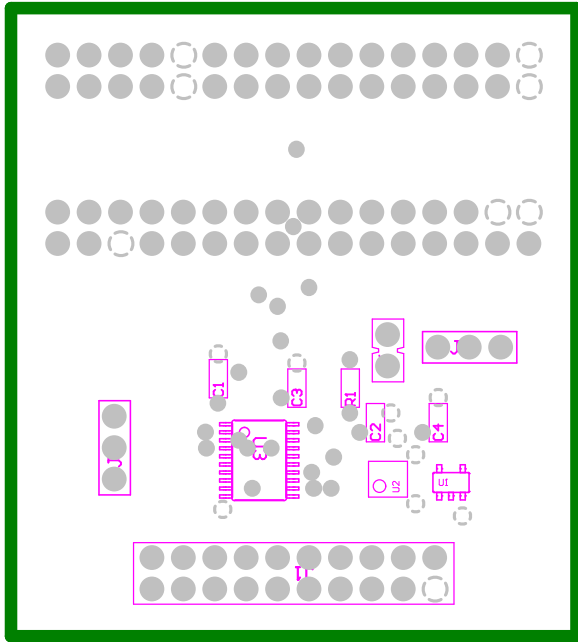


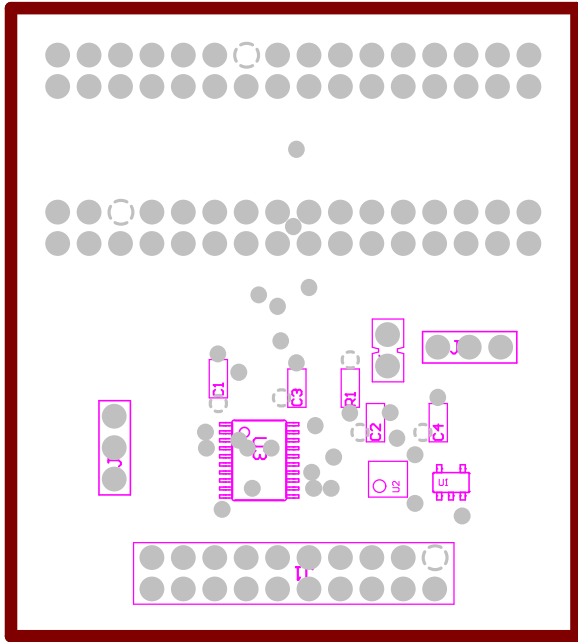
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDM_TM4C129CAMERA A0	SUN REV: Not In VersionControl
LAYER NAME = Component Side	TID #: TIDM_TM4C129CAMERA	
PLOT NAME = Component Side	GENERATED : 8/23/2016 3:25:11 PM	TEXAS INSTRUMENTS



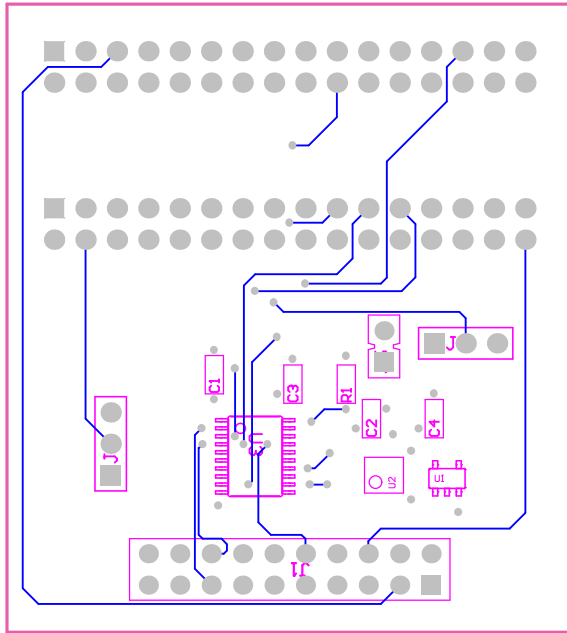
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDM_TM4C129CAMERA A0	SUN REV: Not In VersionControl
LAYER NAME = Ground Plane	TID #: TIDM_TM4C129CAMERA	
PLOT NAME = Ground Plane (GND)	GENERATED : 8/23/2016 3:25:12 PM	TEXAS INSTRUMENTS



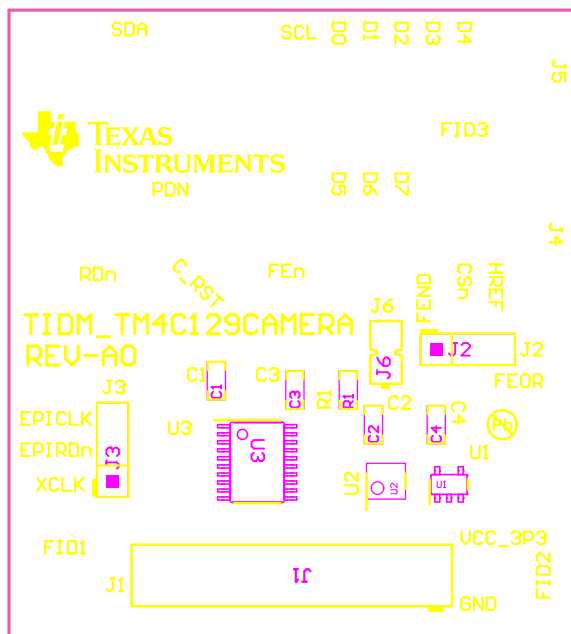
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDM_TM4C129CAMERA A0	SUN REV: Not In VersionControl
LAYER NAME = Power Plane	TID #: TIDM_TM4C129CAMERA	
PLOT NAME = Power Plane (VCC_3P3)	GENERATED : 8/23/2016 3:25:12 PM	TEXAS INSTRUMENTS



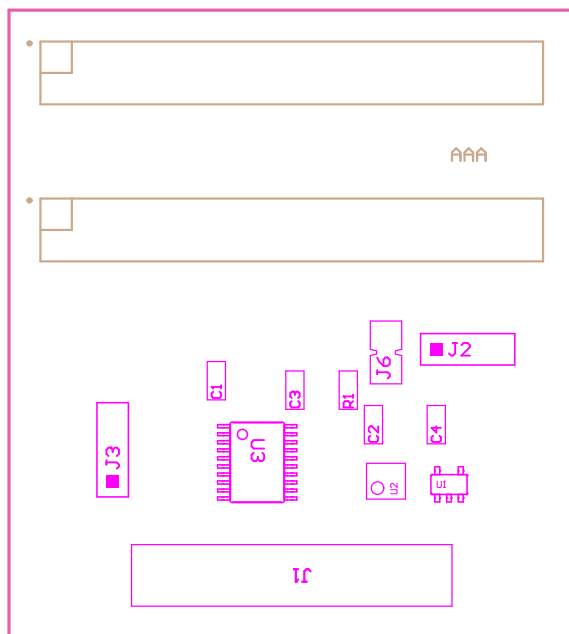
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDM_TM4C129CAMERA A0	SUN REV: Not In VersionControl
LAYER NAME = Solder Side	TID #: TIDM_TM4C129CAMERA	
PLOT NAME = Solder Side	GENERATED : 8/23/2016 3:25:13 PM	TEXAS INSTRUMENTS



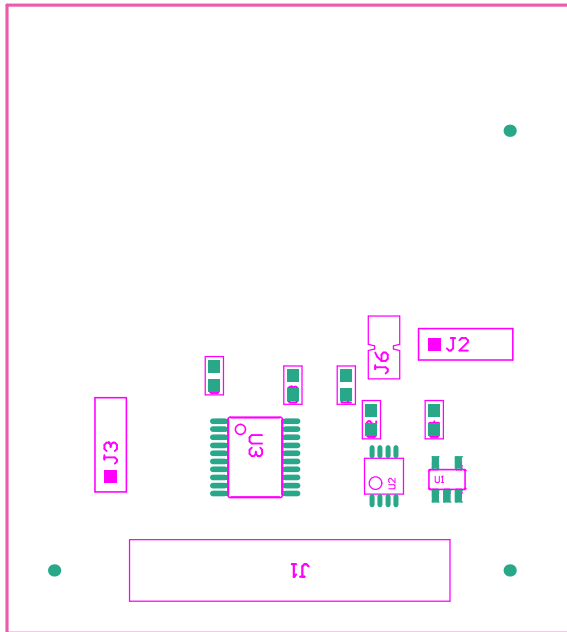
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDM_TM4C129CAMERA A0	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDM_TM4C129CAMERA	
PLOT NAME = Top Silkscreen Overlay	GENERATED : 8/23/2016 3:25:14 PM	TEXAS INSTRUMENTS



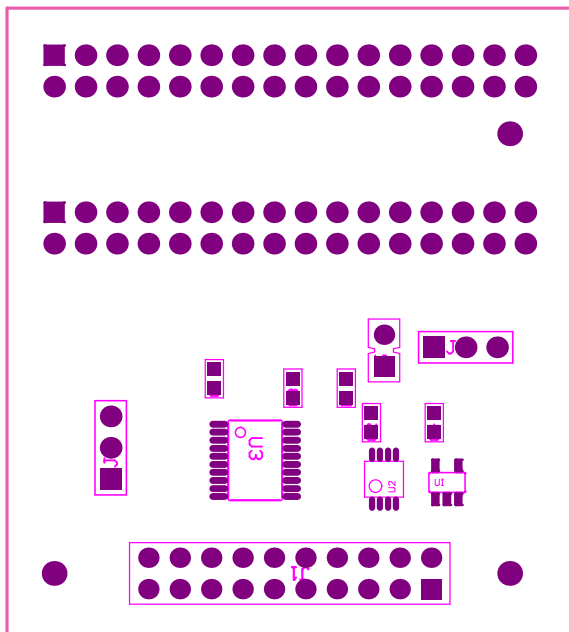
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDM_TM4C129CAMERA A0	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDM_TM4C129CAMERA	
PLOT NAME = Bottom Silkscreen Overlay	GENERATED : 8/23/2016 3:25:14 PM	TEXAS INSTRUMENTS



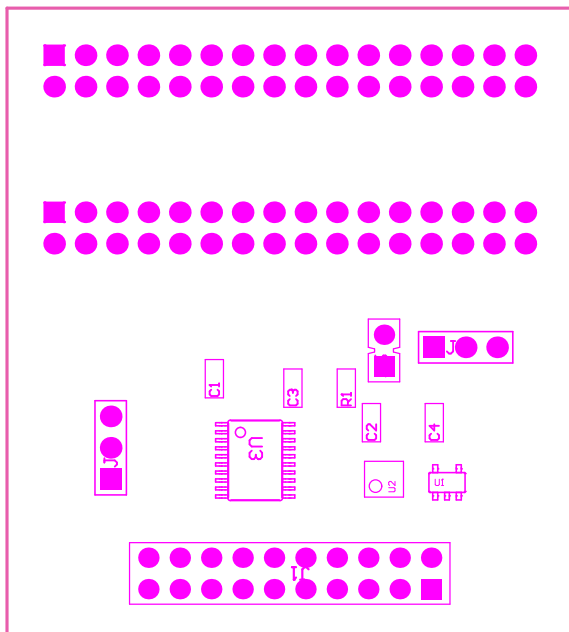
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDM_TM4C129CAMERA A0	SUN REV: Not In VersionControl
LAYER NAME = Top Paste	TID #: TIDM_TM4C129CAMERA	
PLOT NAME = Top Paste Mask Print	GENERATED : 8/23/2016 3:25:15 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDM_TM4C129CAMERA A0	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDM_TM4C129CAMERA	
PLOT NAME = Top Solder Mask Print	GENERATED : 8/23/2016 3:25:15 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDM_TM4C129CAMERA A0	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDM_TM4C129CAMERA	
PLOT NAME = Bottom Solder Mask Print	GENERATED : 8/23/2016 3:25:16 PM	TEXAS INSTRUMENTS

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